1 kV RMS Quad-Channel Digital Isolators

ADuM7440/ADuM7441/ADuM7442

FEATURES

- Small, 16-lead QSOP
- 1000 V rms isolation rating
- Safety and regulatory approvals (pending)
  - UL recognition
    - UL 1577: 1000 V rms for 1 minute
  - CSA Component Acceptance Notice #5A
- Low power operation
  - 5 V operation
    - 2.25 mA per channel maximum @ 0 Mbps to 1 Mbps
    - 11.5 mA per channel maximum @ 25 Mbps
  - 3.3 V operation
    - 1.5 mA per channel maximum @ 0 Mbps to 1 Mbps
    - 8.25 mA per channel maximum @ 25 Mbps
- Bidirectional communication
- Up to 25 Mbps data rate (NRZ)
- 3 V/5 V level translation
- High temperature operation: 105°C
- High common-mode transient immunity: >15 kV/µs

APPLICATIONS

- General-purpose, multichannel isolation
- SPI interface/data converter isolation
- RS-232/RS-422/RS-485 transceivers
- Industrial field bus isolation

GENERAL DESCRIPTION

The ADuM744x[1] are 4-channel digital isolators based on the Analog Devices, Inc., *i*Coupler® technology. Combining high speed CMOS and monolithic air core transformer technologies, these isolation components provide outstanding performance characteristics superior to the alternatives, such as optocoupler devices and other integrated couplers.

The ADuM744x family of quad 1 kV digital isolation devices is packaged in a small 16-lead QSOP. While most 4-channel isolators come in 16-lead wide SOIC packages, the ADuM744x frees almost 70% of board space and yet can still withstand high isolation voltage and meet regulatory requirements such as UL and CSA standards (pending). In addition to the space savings, the ADuM744x offers a lower price than 2.5 kV or 5 kV isolators where only functional isolation is needed.

This family, like many Analog Devices isolators, offers very low power consumption, consuming one-tenth to one-sixth the power of comparable isolators at comparable data rates up to 25 Mbps. Despite the low power consumption, all models of the ADuM744x provide low pulse width distortion (< 5 ns for C grade). In addition, every model has an input glitch filter to protect against extraneous noise disturbances.

The ADuM744x isolators provide four independent isolation channels in a variety of channel configurations and two data rates (see the Ordering Guide) up to 25 Mbps. All models operate with the supply voltage on either side ranging from 3.0 V to 5.5 V, providing compatibility with lower voltage systems as well as enabling voltage translation functionality across the isolation barrier. All products also have an output default high logic state in the absence of the input power.

[1] Protected by U.S. Patents 5,952,849, 6,873,065 and 7,075,329. Other patents pending.

FUNCTIONAL BLOCK DIAGRAMS

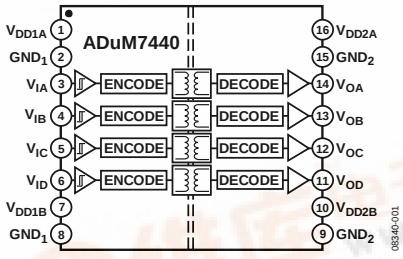

Figure 1. ADuM7440

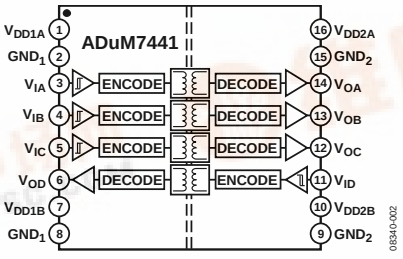

Figure 2. ADuM7441

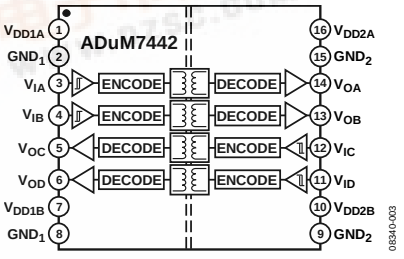

Figure 3. ADuM7442

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REVISION HISTORY

10/09—Revision 0: Initial Version

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS—5 V OPERATION

All typical specifications are at T_A = 25°C, V_{DD1} = V_{DD2} = 5 V. Minimum/maximum specifications apply over the entire recommended operation range of 4.5 V ≤ V_{DD1} ≤ 5.5 V, 4.5 V ≤ V_{DD2} ≤ 5.5 V, and −40°C ≤ T_A ≤ +105°C, unless otherwise noted. Switching specifications are tested with C_L = 15 pF, and CMOS signal levels, unless otherwise noted.

Table 1.

		A Grade			C Grade				
Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
SWITCHING SPECIFICATIONS									
Data Rate				1			25	Mbps	Within PWD limit
Propagation Delay	t_{PHL}, t_{PLH}		50	75	27	40	50	ns	50% input to 50% output
Pulse Width Distortion	PWD		10	25		2	5	ns	$\lvert t_{PLH} - t_{PHL} \rvert$
Change vs. Temperature			5			3		ps/°C	
Pulse Width	PW	250			40			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			40			25	ns	Between any two units
Channel Matching									
Codirectional	t_{PSKCD}			40		2	4	ns	
Opposing-Direction	t_{PSKOD}			40		3	6	ns	
Jitter			2			2		ns	

Table 2.

		1 Mbps—A, C Grades			25 Mbps—C Grade				
Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
SUPPLY CURRENT									
ADuM7440	I_{DD1}		4.3	5.4		28	35	mA	
	I_{DD2}		2.5	3.6		6.0	11	mA	
ADuM7441	I_{DD1}		4.1	4.9		18	26	mA	
	I_{DD2}		3.6	4.7		8.5	14	mA	
ADuM7442	I_{DD1}		3.2	4.0		15	20	mA	
	I_{DD2}		3.2	4.0		12	17	mA	

Table 3. For All Models

Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	0.7 V_{DDx}			V	
Logic Low Input Threshold	V_{IL}			0.3 V_{DDx}	V	
Logic High Output Voltages	V_{OH}	V_{DDx} − 0.1	5.0		V	I_{Ox} = −20 μA, V_{Ix} = V_{IxH}
		V_{DDx} − 0.4	4.8		V	I_{Ox} = −4 mA, V_{Ix} = V_{IxH}
Logic Low Output Voltages	V_{OL}		0.0	0.1	V	I_{Ox} = 20 μA, V_{Ix} = V_{IxL}
			0.2	0.4	V	I_{Ox} = 4 mA, V_{Ix} = V_{IxL}
Input Current per Channel	I_I	−10	+0.01	+10	μA	0 V ≤ V_{Ix} ≤ V_{DDx}
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.76	0.95	mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.57	0.73	mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.26		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.05		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.0		ns	10% to 90%
Common-Mode Transient Immunity[1]	|CM|	15	25		kV/μs	V_{Ix} = V_{DDx}, V_{CM} = 1000 V, transient magnitude = 800 V
Refresh Rate	f_r		1.2		Mbps	

[1] |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining V_O > 0.8 V_{DD}. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—3.3 V OPERATION

All typical specifications are at T_A = 25°C, V_{DD1} = V_{DD2} = 3.3 V. Minimum/maximum specifications apply over the entire recommended operation range of 3.0 V ≤ V_{DD1} ≤ 3.6 V, 3.0 V ≤ V_{DD2} ≤ 3.6 V; and −40°C ≤ T_A ≤ +105°C, unless otherwise noted. Switching specifications are tested with C_L = 15 pF and CMOS signal levels, unless otherwise noted.

Table 4.

		A Grade			C Grade				
Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
SWITCHING SPECIFICATIONS									
Data Rate				1			25	Mbps	Within PWD limit
Propagation Delay	t_{PHL}, t_{PLH}		50	75	33	51	60	ns	50% input to 50% output
Pulse Width Distortion	PWD		10	25		2	5	ns	$\lvert t_{PLH} - t_{PHL} \rvert$
Change vs. Temperature			5			3		ps/°C	
Pulse Width	PW	250			40			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			40			25	ns	Between any two units
Channel Matching									
Codirectional	t_{PSKCD}			40		3	5	ns	
Opposing-Direction	t_{PSKOD}			40		4	7	ns	
Jitter			2			2		ns	

Table 5.

		1 Mbps—A, C Grades			25 Mbps—C Grade				
Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
SUPPLY CURRENT									
ADuM7440	I_{DD1}		3.0	3.8		20	28	mA	
	I_{DD2}		1.8	2.3		4.0	5.0	mA	
ADuM7441	I_{DD1}		2.8	3.5		14	20	mA	
	I_{DD2}		2.5	3.3		5.5	7.5	mA	
ADuM7442	I_{DD1}		2.2	2.7		10	13	mA	
	I_{DD2}		2.2	2.8		8.4	11	mA	

Table 6. For All Models

Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	0.7 V_{DDx}			V	
Logic Low Input Threshold	V_{IL}			0.3 V_{DDx}	V	
Logic High Output Voltages	V_{OH}	V_{DDx} − 0.2	3.3		V	I_{Ox} = −20 μA, V_{Ix} = V_{IxH}
		V_{DDx} − 0.4	3.1		V	I_{Ox} = −4 mA, V_{Ix} = V_{IxH}
Logic Low Output Voltages	V_{OL}		0.0	0.1	V	I_{Ox} = 20 μA, V_{Ix} = V_{IxL}
			0.2	0.4	V	I_{Ox} = 4 mA, V_{Ix} = V_{IxL}
Input Current per Channel	I_I	−10	+0.01	+10	μA	0 V ≤ V_{Ix} ≤ V_{DDx}
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.50		mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.41		mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.18		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.02		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.8		ns	10% to 90%
Common-Mode Transient Immunity[1]	|CM|	15	20		kV/μs	V_{Ix} = V_{DDx}, V_{CM} = 1000 V, transient magnitude = 800 V
Refresh Rate	f_r		1.1		Mbps	

[1] |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining V_O > 0.8 V_{DD}. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—MIXED 5 V/3.3 V OPERATION

All typical specifications are at T_A = 25°C, V_{DD1} = 5 V, V_{DD2} = 3.3 V. Minimum/maximum specifications apply over the entire recommended operation range of 4.5 V ≤ V_{DD1} ≤ 5.5 V, 3.0 V ≤ V_{DD2} ≤ 3.6 V; and −40°C ≤ T_A ≤ +105°C, unless otherwise noted. Switching specifications are tested with C_L = 15 pF and CMOS signal levels, unless otherwise noted.

Table 6.

Parameter	Symbol	A Grade Min	A Grade Typ	A Grade Max	C Grade Min	C Grade Typ	C Grade Max	Unit	Test Conditions
SWITCHING SPECIFICATIONS									
Data Rate				1			25	Mbps	Within PWD limit
Propagation Delay	t_{PHL} t_{PLH}		50	75	29	42	55	ns	50% input to 50% output
Pulse Width Distortion	PWD		10	25		2	5	ns	$\lvert t_{PLH} - t_{PHL} \rvert$
Change vs. Temperature			5			3		ps/°C	
Pulse Width	PW	250			40			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			40			25	ns	Between any two units
Channel Matching									
Codirectional	t_{PSKCD}			40		2	5	ns	
Opposing-Direction	t_{PSKOD}			40		3	6	ns	
Jitter			2			2		ns	

Table 7.

Parameter	Symbol	1 Mbps—A, C Grades Min	1 Mbps—A, C Grades Typ	1 Mbps—A, C Grades Max	25 Mbps—C Grade Min	25 Mbps—C Grade Typ	25 Mbps—C Grade Max	Unit	Test Conditions
SUPPLY CURRENT									
ADuM7440	I_{DD1}		4.4	5.5		28	35	mA	
	I_{DD2}		1.6	2.1		3.5	4.5	mA	
ADuM7441	I_{DD1}		3.7	5.0		19	27	mA	
	I_{DD2}		2.2	2.8		5.2	7.0	mA	
ADuM7442	I_{DD1}		3.2	3.9		15	20	mA	
	I_{DD2}		2.0	2.6		7.8	12	mA	

Table 8. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	0.7 V_{DDx}			V	
Logic Low Input Threshold	V_{IL}			0.3 V_{DDx}	V	
Logic High Output Voltages	V_{OH}	V_{DDx} − 0.1	V_{DDx}		V	I_{Ox} = −20 μA, V_{Ix} = V_{IxH}
		V_{DDx} − 0.4	V_{DDx} − 0.2		V	I_{Ox} = −4 mA, V_{Ix} = V_{IxH}
Logic Low Output Voltages	V_{OL}		0.0	0.1	V	I_{Ox} = 20 μA, V_{Ix} = V_{IxL}
			0.2	0.4	V	I_{Ox} = 4 mA, V_{Ix} = V_{IxL}
Input Current per Channel	I_I	−10	+0.01	+10	μA	0 V ≤ V_{Ix} ≤ V_{DDx}
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.77		mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.40		mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.26		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.02		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity[1]	|CM|	15	20		kV/μs	V_{Ix} = V_{DDx}, V_{CM} = 1000 V, transient magnitude = 800 V
Refresh Rate	f_r		1.2		Mbps	

[1] |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining V_O > 0.8 V_{DD}. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—MIXED 3.3 V/5 V OPERATION

All typical specifications are at T_A = 25°C, V_{DD1} = 3.3 V, V_{DD2} = 5 V. Minimum/maximum specifications apply over the entire recommended operation range of 3.0 V ≤ V_{DD1} ≤ 3.6 V, 4.5 V ≤ V_{DD2} ≤ 5.5 V, and −40°C ≤ T_A ≤ +105°C, unless otherwise noted. Switching specifications are tested with C_L = 15 pF and CMOS signal levels, unless otherwise noted.

Table 9.

Parameter	Symbol	A Grade			C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS									
Data Rate				1			25	Mbps	Within PWD limit
Propagation Delay	t_{PHL}, t_{PLH}		50	75	29	46	60	ns	50% input to 50% output
Pulse Width Distortion	PWD		10	25		2	5	ns	$\lvert t_{PLH} - t_{PHL} \rvert$
Change vs. Temperature			5			3		ps/°C	
Pulse Width	PW	250			40			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			40			30	ns	Between any two units
Channel Matching									
Codirectional	t_{PSKCD}			40		2	5	ns	
Opposing-Direction	t_{PSKOD}			40		3	7	ns	
Jitter			2			2		ns	

Table 10.

Parameter	Symbol	1 Mbps—A, C Grades			25 Mbps—C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max		
SUPPLY CURRENT									
ADuM7440	I_{DD1}		2.7	3.3		18	24	mA	
	I_{DD2}		2.5	3.3		5.7	8.0	mA	
ADuM7441	I_{DD1}		2.5	3.3		12	20	mA	
	I_{DD2}		3.6	4.6		8.0	11	mA	
ADuM7442	I_{DD1}		2.0	2.4		8.9	13	mA	
	I_{DD2}		3.2	4.0		12	15	mA	

Table 11. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	0.7 V_{DDx}			V	
Logic Low Input Threshold	V_{IL}			0.3 V_{DDx}	V	
Logic High Output Voltages	V_{OH}	V_{DDx} − 0.1	V_{DDx}		V	I_{Ox} = −20 μA, V_{Ix} = V_{IxH}
		V_{DDx} − 0.4	V_{DDx} − 0.2		V	I_{Ox} = −4 mA, V_{Ix} = V_{IxH}
Logic Low Output Voltages	V_{OL}		0.0	0.1	V	I_{Ox} = 20 μA, V_{Ix} = V_{IxL}
			0.2	0.4	V	I_{Ox} = 4 mA, V_{Ix} = V_{IxL}
Input Current per Channel	I_I	−10	+0.01	+10	μA	0 V ≤ V_{Ix} ≤ V_{DDx}
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.50	0.60	mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.61	0.73	mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.17		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.03		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity[1]	|CM|	15	20		kV/μs	V_{Ix} = V_{DDx}, V_{CM} = 1000 V, transient magnitude = 800 V
Refresh Rate	f_r		1.1		Mbps	

[1] |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining V_O > 0.8 V_{DD}. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

PACKAGE CHARACTERISTICS

Table 12.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Resistance (Input-to-Output)[1]	R_{I-O}		10^{13}		Ω	
Capacitance (Input-to-Output)[1]	C_{I-O}		2		pF	f = 1 MHz
Input Capacitance[2]	C_I		4.0		pF	
IC Junction-to-Ambient Thermal Resistance	θ_{JA}		76		°C/W	Thermocouple located at center of package underside

[1] The device is considered a 2-terminal device: Pin 1 through Pin 8 are shorted together and Pin 9 through Pin 16 are shorted together.
[2] Input capacitance is from any input data pin to ground.

REGULATORY INFORMATION

The ADuM744x is approved by the organizations listed in Table 13. See Table 17 and the Insulation Lifetime section for recommended maximum working voltages for specific cross-isolation waveforms and insulation levels.

Table 13.

UL (pending)	CSA (Pending)
Recognized under UL 1577 Component Recognition Program[1]	Approved under CSA Component Acceptance Notice #5A
Single Protection, 1000 V rms Isolation Voltage	Basic insulation per CSA 60950-1-03 and IEC 60950-1, 148 V rms (210 V peak) maximum working voltage
File E274400	File 205078

[1] In accordance with UL 1577, each ADuM744x is proof tested by applying an insulation test voltage ≥1200 V rms for 1 sec (current leakage detection limit = 5 µA).

INSULATION AND SAFETY-RELATED SPECIFICATIONS

Table 14.

Parameter	Symbol	Value	Unit	Conditions
Rated Dielectric Insulation Voltage		1000	V rms	1-minute duration
Minimum External Air Gap (Clearance)	L(I01)	3.8	mm min	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage)	L(I02)	2.8	mm min	Measured from input terminals to output terminals, shortest distance path along body
Minimum Internal Gap (Internal Clearance)		2.6	µm min	Insulation distance through insulation
Tracking Resistance (Comparative Tracking Index)	CTI	>175	V	DIN IEC 112/VDE 0303 Part 1
Isolation Group		IIIa		Material Group (DIN VDE 0110, 1/89, Table 1)

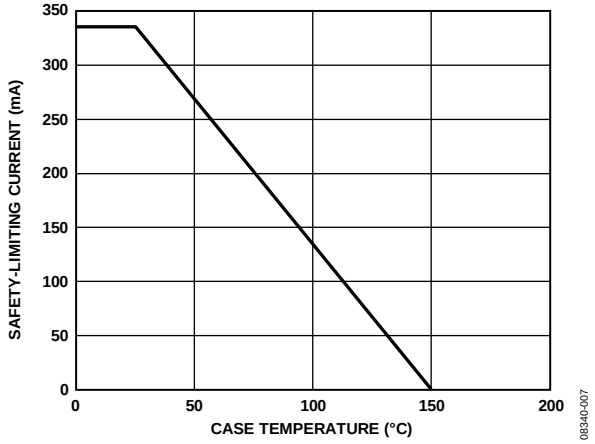


Figure 4. Thermal Derating Curve, Dependence of Safety-Limiting Values with Case Temperature per DIN V VDE V 0884-10

RECOMMENDED OPERATING CONDITIONS

Table 15.

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T_A	−40	+105	°C
Supply Voltages[1]	V_{DD1}, V_{DD2}	3.0	5.5	V
Input Signal Rise and Fall Times			1.0	ms

[1] All voltages are relative to their respective ground. See the DC Correctness and Magnetic Field Immunity section for information on immunity to external magnetic fields.

ABSOLUTE MAXIMUM RATINGS

T_A = 25°C, unless otherwise noted.

Table 16.

Parameter	Rating
Storage Temperature (T_{ST}) Range	−65°C to +150°C
Ambient Operating Temperature (T_A)	−40°C to +105°C
Supply Voltages (V_{DD1}, V_{DD2})	−0.5 V to +7.0 V
Input Voltages (V_{IA}, V_{IB}, V_{IC}, V_{ID})[1, 2]	−0.5 V to V_{DDI} + 0.5 V
Output Voltages (V_{OA}, V_{OB}, V_{OC}, V_{OD}) [1, 2]	−0.5 V to V_{DDO} + 0.5 V
Average Output Current per Pin[3]	
Side 1 (I_{O1})	−10 mA to +10 mA
Side 2 (I_{O2})	−10 mA to +10 mA
Common-Mode Transients[3]	−100 kV/µs to +100 kV/µs

[1] V_{DDI} and V_{DDO} refer to the supply voltages on the input and output sides of a given channel, respectively. See the PC Board Layout section.
[2] See Figure 4 for maximum rated current values for various temperatures.
[3] Refers to common-mode transients across the insulation barrier. Common-mode transients exceeding the absolute maximum ratings may cause latch-up or permanent damage.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Table 17. Maximum Continuous Working Voltage[1]

Parameter	Max	Unit	Constraint
AC Voltage, Bipolar Waveform	420	V peak	50-year minimum lifetime
AC Voltage, Unipolar Waveform			
Basic Insulation	420	V peak	50-year minimum lifetime
DC Voltage			
Basic Insulation	420	V peak	50-year minimum lifetime

[1] Refers to continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

Table 18. Truth Table (Positive Logic)

V_{Ix} Input[1]	V_{DDI} State[2]	V_{DDO} State[3]	V_{Ox} Output[1]	Description
H	Powered	Powered	H	Normal operation; data is high.
L	Powered	Powered	L	Normal operation; data is low.
X	Unpowered	Powered	H	Input unpowered. Outputs are in the default high state. Outputs return to input state within 1 µs of V_{DDI} power restoration. See the pin function descriptions (Table 19 through Table 21) for more details.
X	Powered	Unpowered	Z	Output unpowered. Output pins are in high impedance state. Outputs return to input state within 1 µs of V_{DDO} power restoration. See the pin function descriptions (Table 19 through Table 21) for more details.

[1] V_{Ix} and V_{Ox} refer to the input and output signals of a given channel (A, B, C, or D).
[2] V_{DDI} refers to the power supply on the input side of a given channel (A, B, C, or D).
[3] V_{DDO} refers to the power supply on the output side of a given channel (A, B, C, or D).

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

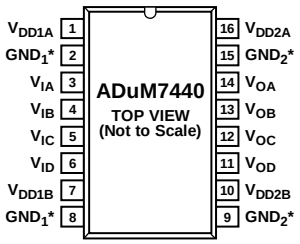


Figure 5. ADuM7440 Pin Configuration

Table 19. ADuM7440 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V_{DD1A}	Supply Voltage A for Isolator Side 1 (3.0 V to 5.5 V). Pin 1 must be connected externally to Pin 7. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD1A} (Pin 1) and GND_1 (Pin 2).
2	GND_1	Ground 1. Ground reference for Isolator Side 1. Pin 2 and Pin 8 are internally connected, and connecting both to GND_1 is recommended.
3	V_{IA}	Logic Input A.
4	V_{IB}	Logic Input B.
5	V_{IC}	Logic Input C.
6	V_{ID}	Logic Input D.
7	V_{DD1B}	Supply Voltage B for Isolator Side 1 (3.0 V to 5.5 V). Pin 7 must be connected externally to Pin 1. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD1B} (Pin 7) and GND_1 (Pin 8).
8	GND_1	Ground 1. Ground reference for Isolator Side 1. Pin 2 and Pin 8 are internally connected, and connecting both to GND_1 is recommended.
9	GND_2	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 15 are internally connected, and connecting both to GND_2 is recommended.
10	V_{DD2B}	Supply Voltage B for Isolator Side 2 (3.0 V to 5.5 V). Pin 10 must be connected externally to Pin 16. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD2B} (Pin 10) and GND_2 (Pin 9).
11	V_{OD}	Logic Output D.
12	V_{OC}	Logic Output C.
13	V_{OB}	Logic Output B.
14	V_{OA}	Logic Output A.
15	GND_2	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 15 are internally connected, and connecting both to GND_2 is recommended.
16	V_{DD2A}	Supply Voltage A for Isolator Side 2 (3.0 V to 5.5 V). Pin 16 must be connected externally to Pin 10. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD2A} (Pin 16) and GND_2 (Pin 15).

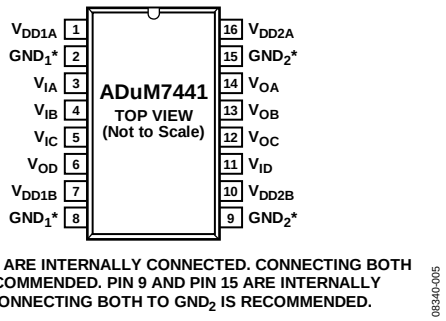


Figure 6. ADuM7441 Pin Configuration

Table 20. ADuM7441 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V_{DD1A}	Supply Voltage A for Isolator Side 1 (3.0 V to 5.5 V). Pin 1 must be connected externally to Pin 7. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD1A} (Pin 1) and GND_1 (Pin 2).
2	GND_1	Ground 1. Ground reference for Isolator Side 1. Pin 2 and Pin 8 are internally connected, and connecting both to GND_1 is recommended.
3	V_{IA}	Logic Input A.
4	V_{IB}	Logic Input B.
5	V_{IC}	Logic Input C.
6	V_{OD}	Logic Output D.
7	V_{DD1B}	Supply Voltage B for Isolator Side 1 (3.0 V to 5.5 V). Pin 7 must be connected externally to Pin 1. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD1B} (Pin 7) and GND_1 (Pin 8).
8	GND_1	Ground 1. Ground reference for Isolator Side 1. Pin 2 and Pin 8 are internally connected, and connecting both to GND_1 is recommended.
9	GND_2	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 15 are internally connected, and connecting both to GND_2 is recommended.
10	V_{DD2B}	Supply Voltage B for Isolator Side 2 (3.0 V to 5.5 V). Pin 10 must be connected externally to Pin 16. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD2B} (Pin 10) and GND_2 (Pin 9).
11	V_{ID}	Logic Input D.
12	V_{OC}	Logic Output C.
13	V_{OB}	Logic Output B.
14	V_{OA}	Logic Output A.
15	GND_2	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 15 are internally connected, and connecting both to GND_2 is recommended.
16	V_{DD2A}	Supply Voltage A for Isolator Side 2 (3.0 V to 5.5 V). Pin 16 must be connected externally to Pin 10. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD2A} (Pin 16) and GND_2 (Pin 15).

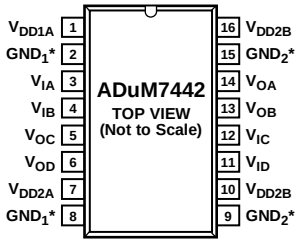


Figure 7. ADuM7442Pin Configuration

Table 21. ADuM7442 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V_{DD1A}	Supply Voltage A for Isolator Side 1 (3.0 V to 5.5 V). Pin 1 must be connected externally to Pin 7. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD1A} (Pin 1) and GND_1 (Pin 2).
2	GND_1	Ground 1. Ground reference for Isolator Side 1. Pin 2 and Pin 8 are internally connected, and connecting both to GND_1 is recommended.
3	V_{IA}	Logic Input A.
4	V_{IB}	Logic Input B.
5	V_{OC}	Logic Output C.
6	V_{OD}	Logic Output D.
7	V_{DD1B}	Supply Voltage B for Isolator Side 1 (3.0 V to 5.5 V). Pin 7 must be connected externally to Pin 1. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD1B} (Pin 7) and GND_1 (Pin 8).
8	GND_1	Ground 1. Ground reference for Isolator Side 1. Pin 2 and Pin 8 are internally connected, and connecting both to GND_1 is recommended.
9	GND_2	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 15 are internally connected, and connecting both to GND_2 is recommended.
10	V_{DD2B}	Supply Voltage B for Isolator Side 2 (3.0 V to 5.5 V). Pin 10 must be connected externally to Pin 16. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD2B} (Pin 10) and GND_2 (Pin 9).
11	V_{ID}	Logic Input D.
12	V_{IC}	Logic Input C.
13	V_{OB}	Logic Output B.
14	V_{OA}	Logic Output A.
15	GND_2	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 15 are internally connected, and connecting both to GND_2 is recommended.
16	V_{DD2A}	Supply Voltage A for Isolator Side 2 (3.0 V to 5.5 V). Pin 16 must be connected externally to Pin 10. Connect a ceramic bypass capacitor of value 0.01 µF to 0.1 µF between V_{DD2A} (Pin 16) and GND_2 (Pin 15).

TYPICAL PERFORMANCE CHARACTERISTICS

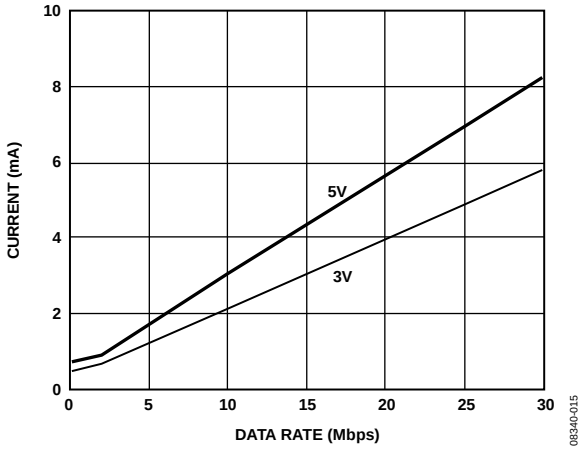


Figure 8. Typical Supply Current per Input Channel vs. Data Rate for 5 V and 3 V Operation

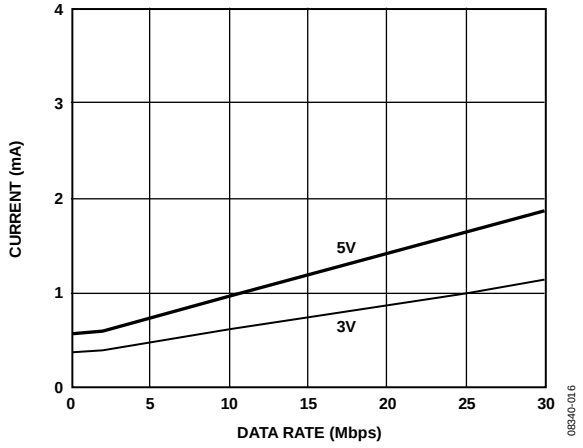


Figure 9. Typical Supply Current per Output Channel vs. Data Rate for 5 V and 3 V Operation (No Output Load)

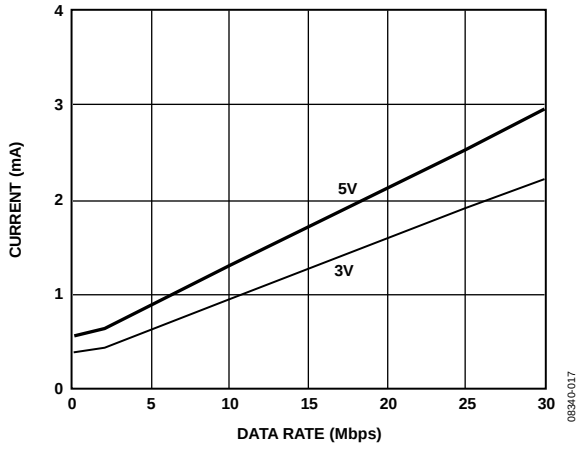


Figure 10. Typical Supply Current per Output Channel vs. Data Rate for 5 V and 3 V Operation (15 pF Output Load)

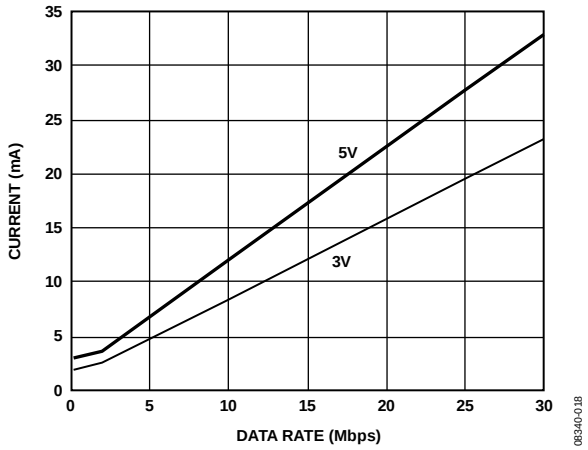


Figure 11. Typical ADuM7440 V_{DD1} Supply Current vs. Data Rate for 5 V and 3 V Operation

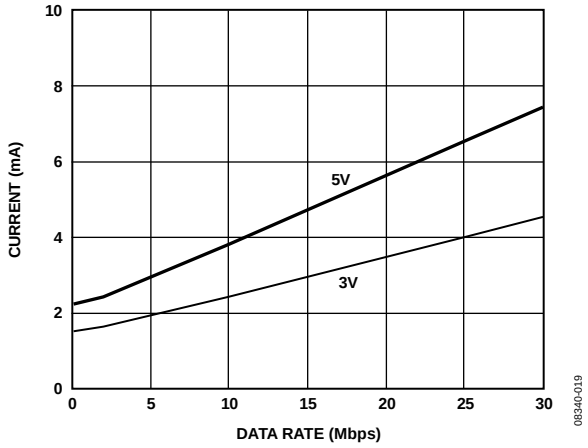


Figure 12. Typical ADuM7440 V_{DD2} Supply Current vs. Data Rate for 5 V and 3 V Operation

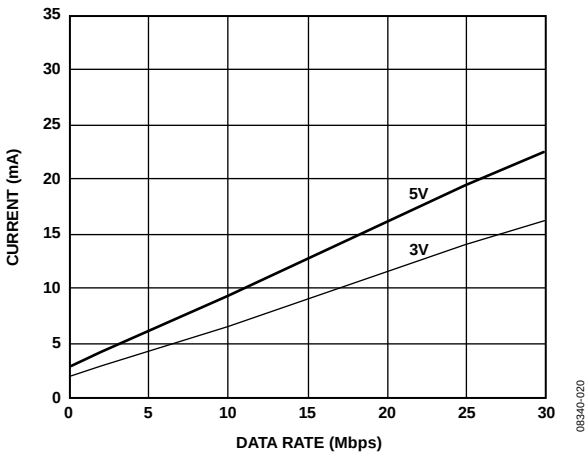


Figure 13. Typical ADuM7441 V_{DD1} Supply Current vs. Data Rate for 5 V and 3 V Operation

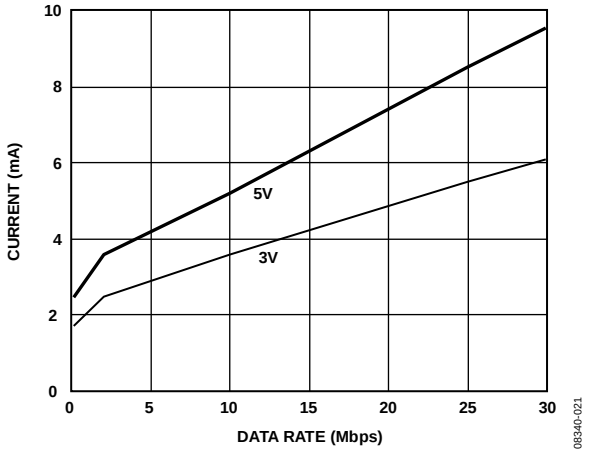


Figure 14. Typical ADuM7441 V_{DD2} Supply Current vs. Data Rate for 5 V and 3 V Operation

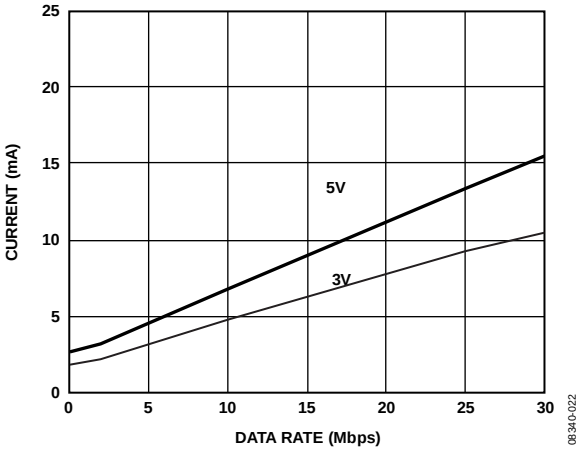


Figure 15. Typical ADuM7442 V_{DD1} or V_{DD2} Supply Current vs. Data Rate for 5 V and 3 V Operation

APPLICATIONS INFORMATION

PC BOARD LAYOUT

The ADuM744x digital isolators require no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins (see Figure 16). A total of four bypass capacitors should be connected between Pin 1 and Pin 2 for V_{DD1A}, between Pin 7 and Pin 8 for V_{DD1B}, between Pin 9 and Pin 10 for V_{DD2B}, and between Pin 15 and Pin 16 for V_{DD2A}. Supply V_{DD1A} Pin 1 and V_{DD1B} Pin 7 should be connected together and supply V_{DD2B} Pin 10 and V_{DD2A} Pin 16 should be connected together. The capacitor values should be between 0.01 µF and 0.1 µF. The total lead length between both ends of the capacitor and the power supply pin should not exceed 20 mm.

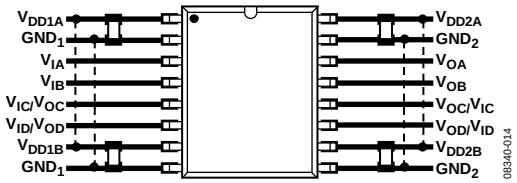


Figure 16. Recommended Printed Circuit Board Layout

In applications involving high common-mode transients, it is important to minimize board coupling across the isolation barrier. Furthermore, users should design the board layout so that any coupling that does occur equally affects all pins on a given component side. Failure to ensure this can cause voltage differentials between pins exceeding the absolute maximum ratings of the device, thereby leading to latch-up or permanent damage.

PROPAGATION DELAY-RELATED PARAMETERS

Propagation delay is a parameter that describes the time it takes a logic signal to propagate through a component. The input-to-output propagation delay time for a high-to-low transition may differ from the propagation delay time of a low-to-high transition.

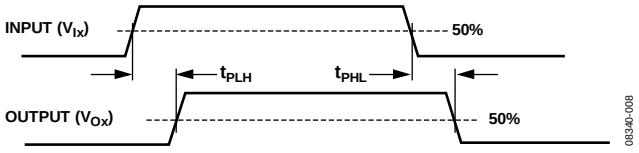


Figure 17. Propagation Delay Parameters

Pulse width distortion is the maximum difference between these two propagation delay values and an indication of how accurately the timing of the input signal is preserved.

Channel-to-channel matching refers to the maximum amount the propagation delay differs between channels within a single ADuM744x component.

Propagation delay skew refers to the maximum amount the propagation delay differs between multiple ADuM744x components operating under the same conditions.

DC CORRECTNESS AND MAGNETIC FIELD IMMUNITY

Positive and negative logic transitions at the isolator input cause narrow (~1 ns) pulses to be sent to the decoder using the transformer. The decoder is bistable and is, therefore, either set or reset by the pulses, indicating input logic transitions. In the absence of logic transitions at the input for more than ~1 µs, a periodic set of refresh pulses indicative of the correct input state is sent to ensure dc correctness at the output. If the decoder receives no internal pulses of more than approximately 5 µs, the input side is assumed to be unpowered or nonfunctional, in which case the isolator output is forced to a default high state by the watchdog timer circuit.

The magnetic field immunity of the ADuM744x is determined by the changing magnetic field, which induces a voltage in the transformer's receiving coil large enough to either falsely set or reset the decoder. The following analysis defines the conditions under which this can occur. The 3 V operating condition of the ADuM744x is examined because it represents the most susceptible mode of operation.

The pulses at the transformer output have an amplitude greater than 1.0 V. The decoder has a sensing threshold at about 0.5 V, thus establishing a 0.5 V margin in which induced voltages can be tolerated. The voltage induced across the receiving coil is given by

$$V = (-d\beta / dt) \sum \pi r_n^2; n = 1, 2, \ldots, N$$

where:
β is magnetic flux density (gauss).
r_n is the radius of the n^{th} turn in the receiving coil (cm).
N is the number of turns in the receiving coil.

Given the geometry of the receiving coil in the ADuM744x and an imposed requirement that the induced voltage be, at most, 50% of the 0.5 V margin at the decoder, a maximum allowable magnetic field at a given frequency can be calculated. The result is shown in Figure 18.

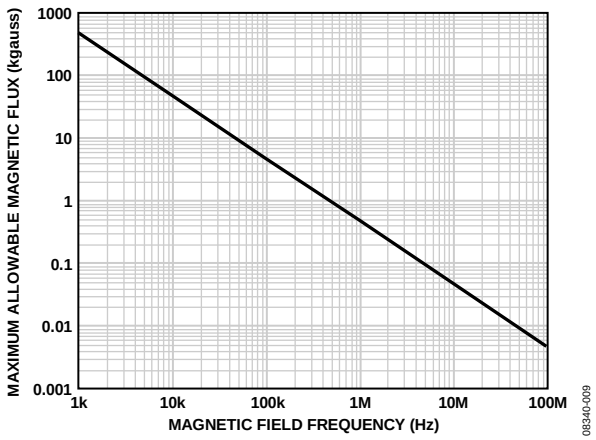


Figure 18. Maximum Allowable External Magnetic Flux Density

For example, at a magnetic field frequency of 1 MHz, the maximum allowable magnetic field of 0.5 kgauss induces a voltage of 0.25 V at the receiving coil. This is about 50% of the sensing threshold and does not cause a faulty output transition. Similarly, if such an event occurred during a transmitted pulse (and was of the worst-case polarity), it would reduce the received pulse from >1.0 V to 0.75 V, still well above the 0.5 V sensing threshold of the decoder.

The preceding magnetic flux density values correspond to specific current magnitudes at given distances from the ADuM744x transformers. Figure 19 shows these allowable current magnitudes as a function of frequency for selected distances. As shown, the ADuM744x is extremely immune and can be affected only by extremely large currents operated at high frequency very close to the component. For the 1 MHz example noted previously, a 1.2 kA current would have to be placed 5 mm away from the ADuM744x to affect the operation of the component.

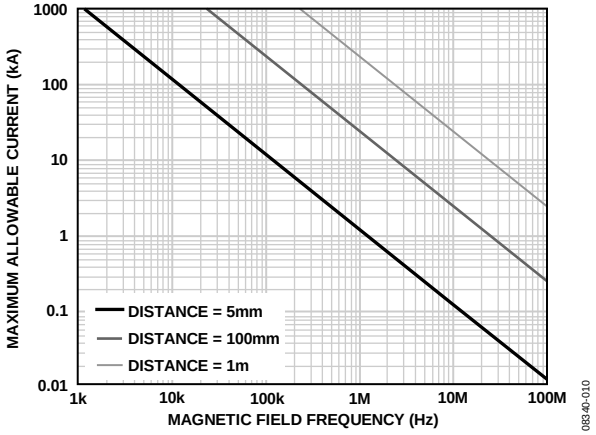


Figure 19. Maximum Allowable Current for Various Current-to-ADuM744x Spacings

Note that at combinations of strong magnetic field and high frequency, any loops formed by printed circuit board traces can induce error voltages sufficiently large enough to trigger the thresholds of succeeding circuitry. Care should be taken in the layout of such traces to avoid this possibility.

POWER CONSUMPTION

The supply current at a given channel of the ADuM744x isolator is a function of the supply voltage, the data rate of the channel, and the output load of the channel.

For each input channel, the supply current is given by

$$I_{DDI} = I_{DDI\,(Q)} \qquad f \le 0.5\,f_r$$

$$I_{DDI} = I_{DDI\,(D)} \times (2f - f_r) + I_{DDI\,(Q)} \qquad f > 0.5\,f_r$$

For each output channel, the supply current is given by

$$I_{DDO} = I_{DDO\,(Q)} \qquad f \le 0.5\,f_r$$

$$I_{DDO} = (I_{DDO\,(D)} + (0.5 \times 10^{-3}) \times C_L \times V_{DDO}) \times (2f - f_r) + I_{DDO\,(Q)} \qquad f > 0.5\,f_r$$

where:
$I_{DDI\,(D)}$, $I_{DDO\,(D)}$ are the input and output dynamic supply currents per channel (mA/Mbps).
C_L is the output load capacitance (pF).
V_{DDO} is the output supply voltage (V).
f is the input logic signal frequency (MHz); it is half the input data rate, expressed in units of Mbps.
f_r is the input stage refresh rate (Mbps).
$I_{DDI\,(Q)}$, $I_{DDO\,(Q)}$ are the specified input and output quiescent supply currents (mA).

To calculate the total V_{DD1} and V_{DD2} supply current, the supply currents for each input and output channel corresponding to V_{DD1} and V_{DD2} are calculated and totaled. Figure 8 and Figure 9 show per-channel supply currents as a function of data rate for an unloaded output condition. Figure 10 shows the per-channel supply current as a function of data rate for a 15 pF output condition. Figure 11 through Figure 15 show the total V_{DD1} and V_{DD2} supply current as a function of data rate for ADuM7440/ADuM7441/ADuM7442 channel configurations.

INSULATION LIFETIME

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation is dependent on the characteristics of the voltage waveform applied across the insulation. In addition to the testing performed by the regulatory agencies, Analog Devices carries out an extensive set of evaluations to determine the lifetime of the insulation structure within the ADuM744x.

Analog Devices performs accelerated life testing using voltage levels higher than the rated continuous working voltage. Acceleration factors for several operating conditions are determined. These factors allow calculation of the time to failure at the actual working voltage. The values shown in Table 17 summarize the peak voltage for 50 years of service life for a bipolar ac operating condition and the maximum CSA approved working voltages. In many cases, the approved working voltage is higher than 50-year service life voltage. Operation at these high working voltages can lead to shortened insulation life in some cases.

The insulation lifetime of the ADuM744x depends on the voltage waveform type imposed across the isolation barrier. The *i*Coupler insulation structure degrades at different rates depending on whether the waveform is bipolar ac, unipolar ac, or dc. Figure 20, Figure 21, and Figure 22 illustrate these different isolation voltage waveforms.

Bipolar ac voltage is the most stringent environment. The goal of a 50-year operating lifetime under the ac bipolar condition determines the Analog Devices recommended maximum working voltage.

In the case of unipolar ac or dc voltage, the stress on the insulation is significantly lower. This allows operation at higher working voltages while still achieving a 50-year service life. The working voltages listed in Table 17 can be applied while maintaining the 50-year minimum lifetime provided the voltage conforms to either the unipolar ac or dc voltage case. Any cross-insulation voltage waveform that does not conform to Figure 21 or Figure 22 should be treated as a bipolar ac waveform, and its peak voltage should be limited to the 50-year lifetime voltage value listed in Table 17.

Note that the voltage presented in Figure 21 is shown as sinusoidal for illustration purposes only. It is meant to represent any voltage waveform varying between 0 V and some limiting value. The limiting value can be positive or negative, but the voltage cannot cross 0 V.

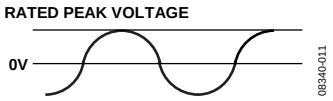


Figure 20. Bipolar AC Waveform

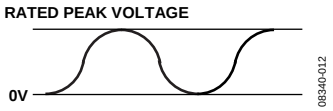


Figure 21. Unipolar AC Waveform

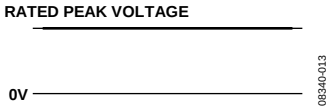
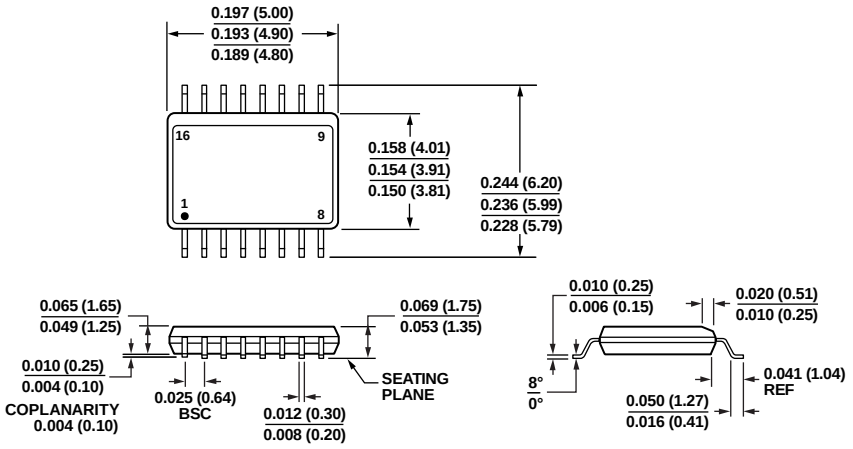


Figure 22. DC Waveform

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-137-AB
CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETERS DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

012808-A

Figure 23. 16-Lead Shrink Small Outline Package [QSOP]
(RQ-16)
(Dimensions shown in inches and (millimeters)

ORDERING GUIDE

Model	Number of Inputs, V_{DD1} Side	Number of Inputs, V_{DD2} Side	Maximum Data Rate	Maximum Propagation Delay, 5 V	Maximum Pulse Width Distortion (ns)	Temperature Range	Package Description	Package Option
ADuM7440ARQZ[1]	4	0	1 Mbps	75 ns	25	−40°C to +105°C	16-Lead QSOP	RQ-16
ADuM7440ARQZ-RL7[1]	4	0	1 Mbps	75 ns	25	−40°C to +105°C	16-Lead QSOP, 7″ Reel	RQ-16
ADuM7440CRQZ[1]	4	0	25 Mbps	50 ns	5	−40°C to +105°C	16-Lead QSOP	RQ-16
ADuM7440CRQZ-RL7[1]	4	0	25 Mbps	50 ns	5	−40°C to +105°C	16-Lead QSOP, 7″ Reel	RQ-16
ADuM7441ARQZ[1]	3	1	1 Mbps	75 ns	25	−40°C to +105°C	16-Lead QSOP	RQ-16
ADuM7441ARQZ-RL7[1]	3	1	1 Mbps	75 ns	25	−40°C to +105°C	16-Lead QSOP, 7″ Reel	RQ-16
ADuM7441CRQZ[1]	3	1	25 Mbps	50 ns	5	−40°C to +105°C	16-Lead QSOP	RQ-16
ADuM7441CRQZ-RL7[1]	3	1	25 Mbps	50 ns	5	−40°C to +105°C	16-Lead QSOP, 7″ Reel	RQ-16
ADuM7442ARQZ[1]	2	2	1 Mbps	75 ns	25	−40°C to +105°C	16-Lead QSOP	RQ-16
ADuM7442ARQZ-RL7[1]	2	2	1 Mbps	75 ns	25	−40°C to +105°C	16-Lead QSOP, 7″ Reel	RQ-16
ADuM7442CRQZ[1]	2	2	25 Mbps	50 ns	5	−40°C to +105°C	16-Lead QSOP	RQ-16
ADuM7442CRQZ-RL7[1]	2	2	25 Mbps	50 ns	5	−40°C to +105°C	16-Lead QSOP, 7″ Reel	RQ-16

[1] Z = RoHS Compliant Part.

NOTES

NOTES